UMW AO3481

-30 V P-Channel MOSFET

1.Description

The AO3481 provide excellent RDS(ON) , low gate charge and operation gate voltages as low as 2.5V. This device is suitable for use as a load switch or other general applications.

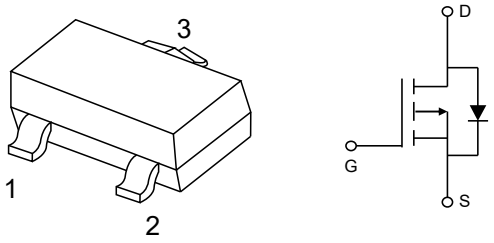
2.Features

- V_{DS}(V)=-30V
- I_D =-4A
- $R_{DS(ON)}$ <41mΩ(V_{GS}=-10V)
- $R_{DS(ON)}$ <47mΩ(V_{GS}=-4.5V)
- RoHS and Halogen-Free Compliant

3.Pinning information

Pin	Symbol	Description
1	G	GATE
2	S	SOURCE
3	D	DRAIN

SOT-23



4.Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current	T_A=25°C	I_D	-4	A
	T_A=70°C		-3.2	
Pulsed Drain Current [C]		I_{DM}	-27	
Power Dissipation [B]	T_A=25°C	P_D	1.4	W
	T_A=70°C		0.9	
Junction and Storage Temperature Range		T_J,T_{STG}	-55 to 150	°C

5.Thermal Characteristics

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient [A]	t ≤ 10s	$R_{\theta JA}$	70	90	°C/W
Maximum Junction-to-Ambient [A D]	Steady-State		100	125	°C/W
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	63	80	°C/W

6.Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	BV_{DSS}	I_D=-250μA, V_{GS}=0V	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V			-1	μA
		T_J=55°C			-5	
Gate-Body leakage current	I_{GSS}	V_{DS}=0V, V_{GS}=±12V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250μA	-0.5	-0.9	-1.3	V
On-State Drain Current	$I_{D(ON)}$	V_{GS}=-10V, V_{DS}=-5V	-27			A
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D=-4.0A		41	50	mΩ
		V_{GS}=-4.5V, I_D=-3.5A		47	60	mΩ
		V_{GS}=-2.5V, I_D=-2.5A		60	85	mΩ
Forward Transconductance	g_{FS}	V_{DS}=-5V, I_D=-4.0A		17		S
Diode Forward Voltage	V_{SD}	I_S=-1A, V_{GS}=0V		-0.7	-1	V
Maximum Body-Diode Continuous Current	I_S				-2	A
Input Capacitance	C_{iss}	V_{GS}=0V, V_{DS}=-15V, f=1MHz		645		pF
Output Capacitance	C_{oss}			80		pF
Reverse Transfer Capacitance	C_{rss}			55		pF
Gate resistance	R_g	V_{GS}=0V, V_{DS}=0V, f=1MHz	4	7.8	12	Ω
Total Gate Charge	Q_g(10V)	V_{GS}=-10V, V_{DS}=-15V, I_D=-4.0A		14	20	nC
Total Gate Charge	Q_g(4.5V)			7		nC
Gate Source Charge	Q_{gs}			1.5		nC
Gate Drain Charge	Q_{gd}			2.5		nC
Turn-On DelayTime	$t_{D(on)}$	V_{GS}=-10V, V_{DS}=-15V, R_L=3.75Ω, R_{GEN}=3Ω		6.5		ns
Turn-On Rise Time	t_r			3.5		ns
Turn-Off DelayTime	$t_{D(off)}$			41		ns
Turn-Off Fall Time	t_f			9		ns
Body Diode Reverse Recovery Time	t_{rr}	I_F=-4.0A, dI/dt=100A/μs		11		ns
Body Diode Reverse Recovery Charge	Q_{rr}	I_F=-4.0A, dI/dt=100A/μs		3.5		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in ^{2} FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)}$=150°C, using ≤ 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}$=150°C. The SOA curve provides a single pulse rating.

7.1Typical Characterisitics

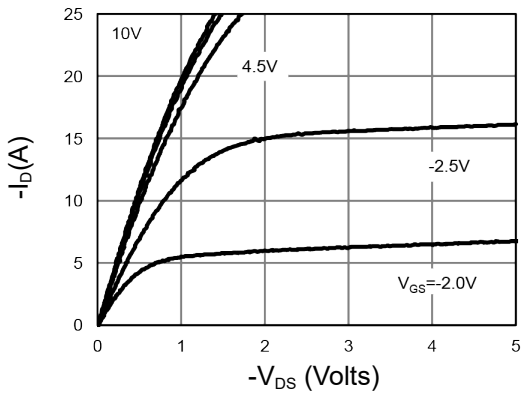


Fig 1: On-Region Characteristics (Note E)

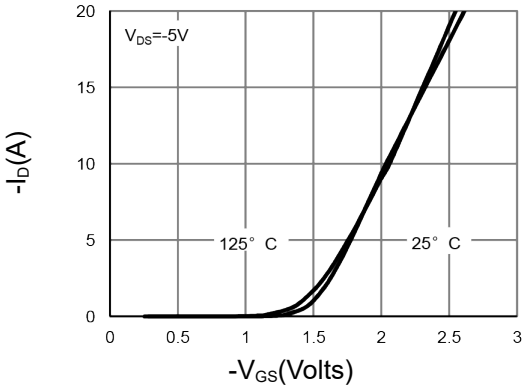


Figure 2: Transfer Characteristics (Note E)

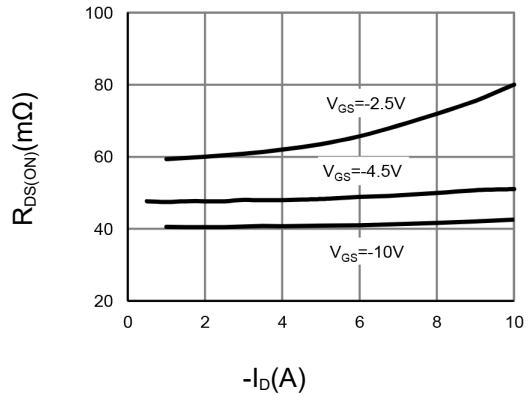


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

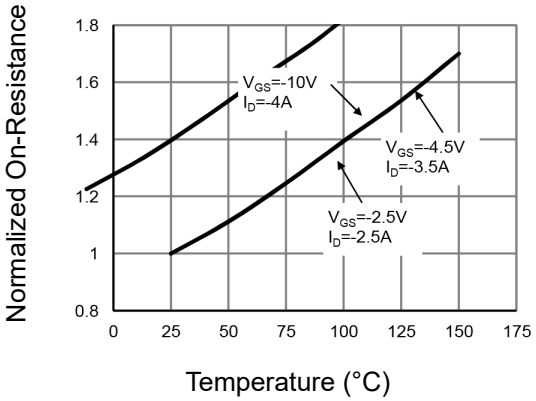


Figure 4: On-Resistance vs. Junction Temperature (Note E)

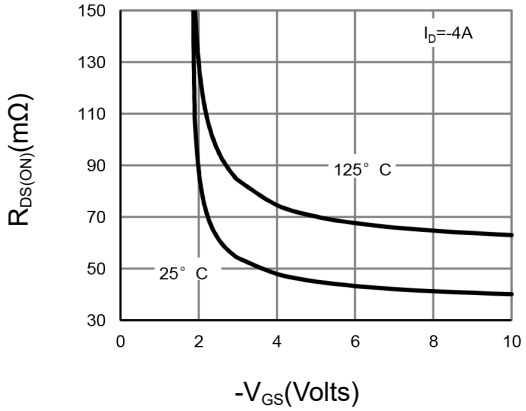


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

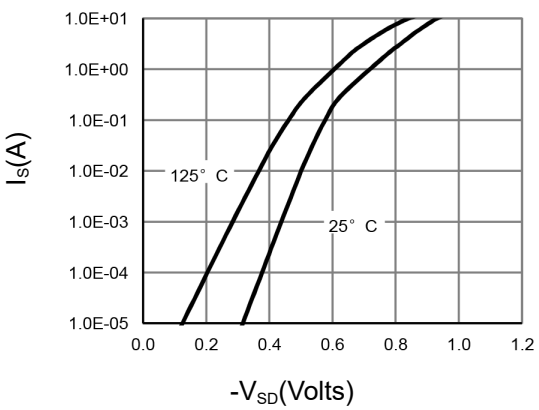


Figure 6: Body-Diode Characteristics(Note E)

7.2Typical Characterisitics

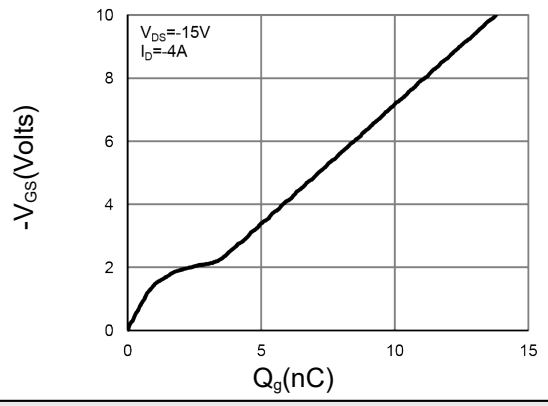


Figure 7: Gate-Charge Characteristics

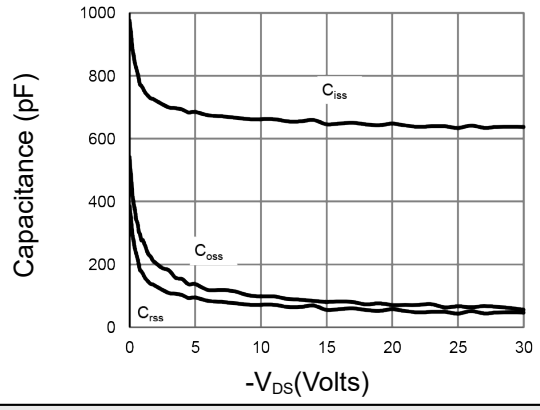


Figure 8: Capacitance Characteristics

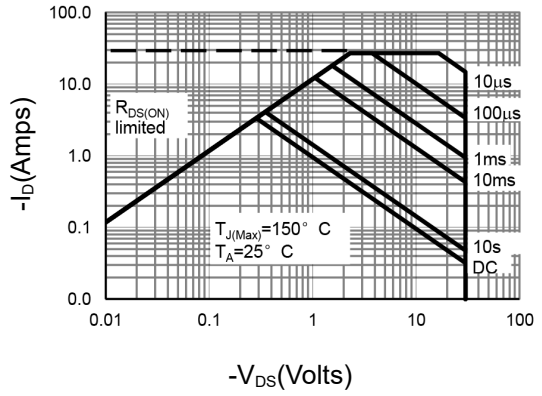


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

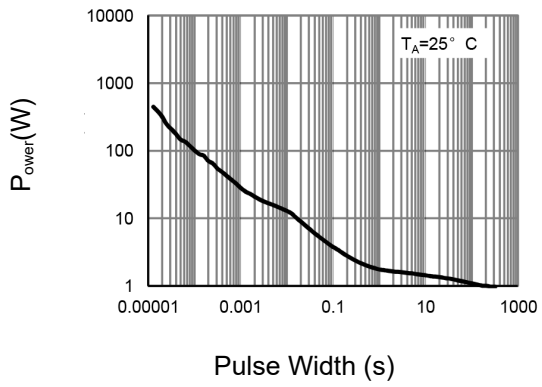


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

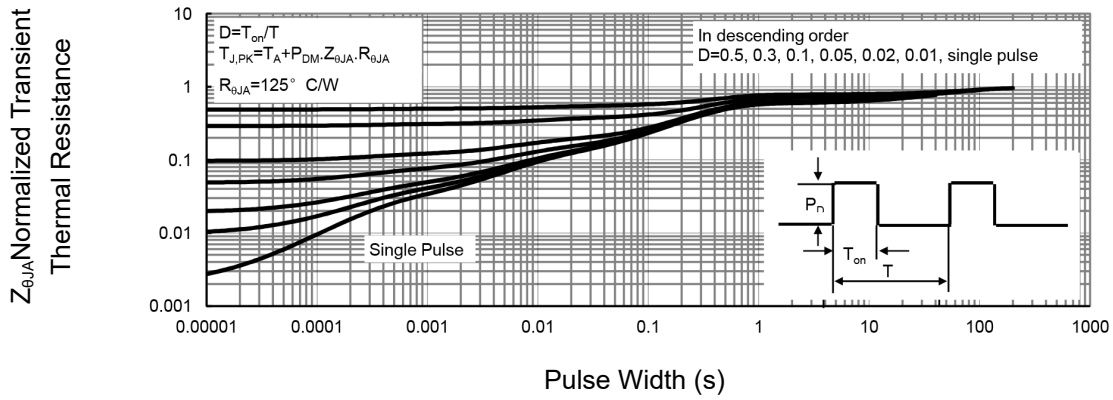
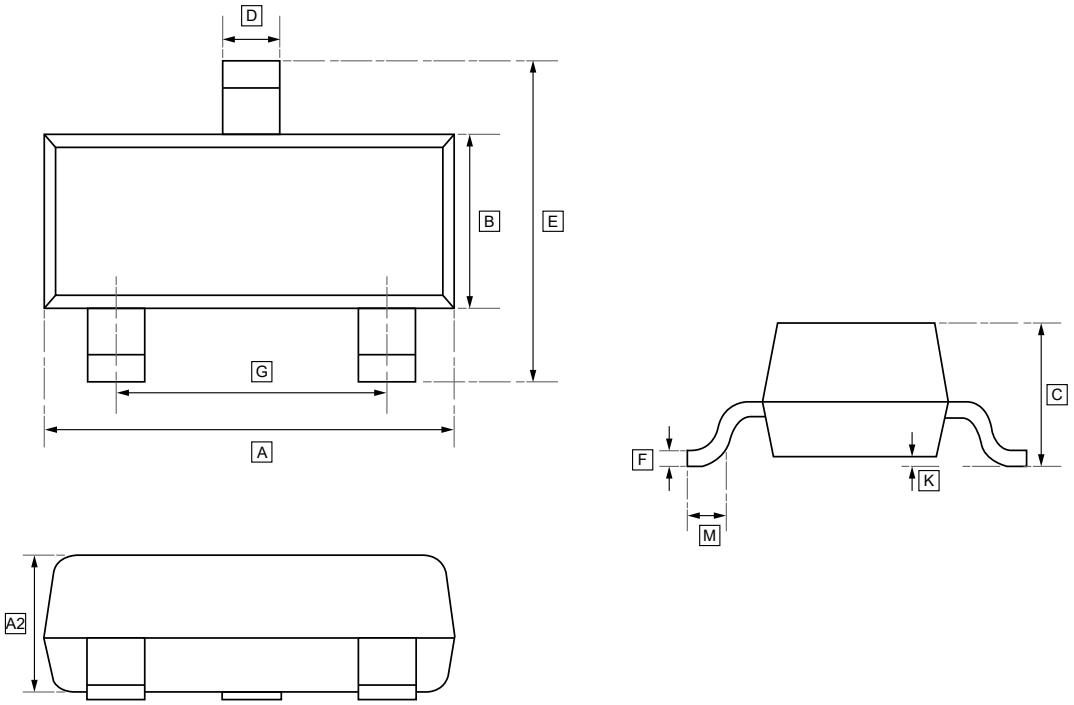


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

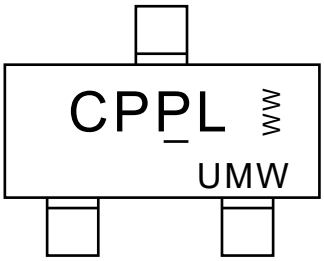
8.SOT-23 Package Outline Dimensions



DIMENSIONS (mm are the original dimensions)

Symbol	A	B	C	D	E	G	K	M	A2	F
Min	2.80	1.20	0.90	0.32	2.25	1.80	0.00	0.30	0.95	0.095
Max	3.04	1.40	1.10	0.55	2.55	2.00	0.10	-	1.05	0.115

9.Ordering Information



WW: Batch Code

Order Code	Package	Base QTY	Delivery Mode
UMW AO3481	SOT-23	3000	Tape and reel

10.Disclaimer

UMW reserves the right to make changes to all products, specifications. Customers should obtain the latest version of product documentation and verify the completeness and currency of the information before placing an order.

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